

# 3C-LINK 40km 1310nm SFP+ Optical Transceiver 3C-SFP+13-ER

#### **Features**

- Compliant with SFF-8431,SFF-8432 and IEE802.3ae
- 10GBASE-ER, and 2G/4G/8G/10G Fiber Channel applications.
- Cooled EML transmitter and PIN receiver
- link length up to 40km
- Low Pow er Dissipation 1.5W Maximum
- -5°Cto 70°COperating Case Temperature
- Single 3.3V pow ersupply
- Diagnostic Performance Monitoring of module temperature, supply Voltages, laser bias current, transmit optical pow er, receive optical pow er
- RoHS6 compliant and lead free /



### **Applications**

- 10GBASE-ER (with/without FEC)
- 10G Fiber Channel (w ith/without FEC)

### Description

3C-LINK SFP+ER 1310nm Transceiver is a "Limiting module", designed for 10GBASE-ER, and 2G/4G/ 8G/10G Fiber- Channel applications.

The transceiver consists of two sections: The transmitter section incorporates a colded EML laser. And the receiver section consists of a PIN photodiode integrated with a TIA. All modules satisfy class I laser safety requirements. Digital diagnostics functions are available via a 2-wire serial interface, as specified in SFF-8472, w hich allows real-time access to device operating parameters such as transceiver temperature, laser bias current, transmitted optical power, received optical power and transceiver supply voltage.



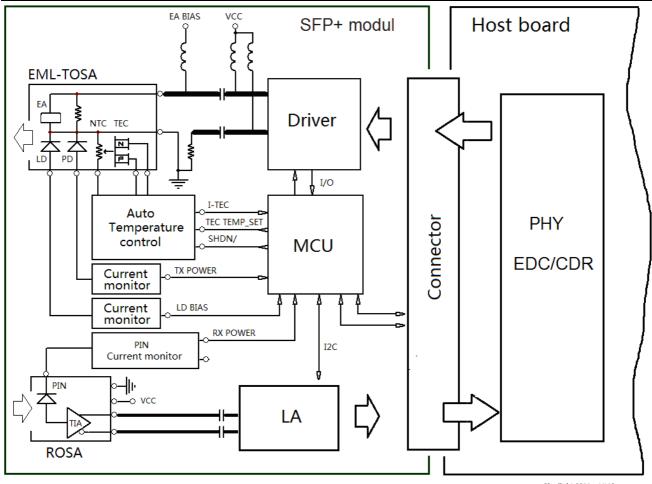


Figure 1. Module Block Diagram

Gigalight 2011 -- HHC

**Absolute Maximum Ratings** 

Param eter	Sym bol	Min	Max	Unit
Supply Voltage	Vcc	-0.5	3.8	V
Storage Temperature	Tst	-40	85	°C
Relative Humidity	Rh	0	85	%

**Operating Conditions** 

Param eter	Sym bol	Min	Typical	Max	Unit
Supply Voltage	Vcc	3.13	3.3	3.46	V



Supply current	Icc	-	360	450	mA
Operating Case temperature	Tca	-5	-	70	°C
Module Power Dissipation	Pm	-	1.2	1.5	W

**Transmitter Specifications - Optical** 

Param eter	Sym bol	Min	Typical	Max	Unit
Center Wav elength	λο	1270		1350	nm
Spectral Width (-20dB)	Δλ20	-	-	0.3	nm
Av erage Optical Power	Ро	-4.7	-	+4	dBm
Optical Power in OMA	OMA	-2.1			dBm
Side Mode Suppression Ratio	SMSR	30	-	-	dB
Optical Transmit Power (disabled)	PTX_DISABLE	-	-	-30	dBm
Extinction Ratio	ER	8.2	-	-	dB
Relative Intensity Noise	RIN	-	-	-128	dB/Hz
Optical Return Loss Tolerance	Orl	-	-	21	dB

Receiver Specifications - Optical

Param eter	Sym bol	Min	Typical	Max	Unit
Input Operating Wavelength	λ	1260	-	1600	nm
Av erage receiv e power	Pavg	-15.8	-	-1.0	dBm
Receiversensitivity in 10.3Gbps(OMA)	Rsen1	-	-	-14.1	dBm
Stressed receiver sensitivity in 10.3Gbps(OMA)	Rsen2	-	-	-11.3	dBm
Reflectance	Rrx	-	-	-26	dB
LOS Asserted	Lsa	-28	-	-	dBm
LOS De-Asserted	Lda	-	-	-19	dBm
LOS Hy steresis	Lh	0.5	-	-	dB

Notes:
[1] Measured with conformance test signal for BER =  $10^{-12}$ . The stressed sensitivity values in the table are for system level BER measurements which include the effects of CDR circuits. It is recommended that at least 0.4 dB additional margin be allocated if component level measurements are made without the effects of CDR circuits.



**Transmitter Specifications – Electrical** 

Param eter	Symbol	Min	Typical	Max	Unit
Data Rate	Mra	1.0	10.3	11.3	Gbps
Input differential impedance	Rim	-	100	-	Ω
Differential data Input	VtxDIFF	120	-	850	mV
Transmit Disable Voltage	VD	2.0	-	Vcc3+0.3	V
Transmit Enable Voltage	Ven	0	-	+0.8	V
Transmit Disable Assert Time	Vn	-	-	100	us

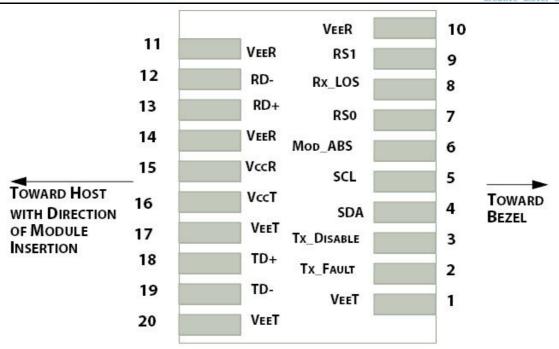
Receiver Specifications - Electrical

Param eter	Symbol	Min	Typical	Max	Unit
Data Rate	Mra	-	10.3	11.3	Gbps
Diff erential Output Swing	Vout P-P	350	-	850	mV
Rise/Fall Time	Tr / Tf	24	-	-	ps
Loss of Signal –Asserted	VOH	2	-	Vcc3+0.3-	V
Loss of Signal –Negated	VOL	0	-	+0.4	V

**Digital Diagnostic Functions** 

Param eter	Symbol	Min.	Max	Unit	Notes	
Accuracy						
Transceiv er Temperature	DMI_Temp	-3	+3	degC	Ov er operating temp	
TX Output optical power	DMI_TX	-3	+3	dB		
RX Input optical power	DMI_RX	-3	+3	dB	-3dBm to -12dBm range	
Transceiv er Supply voltage	DMI_VCC	-0.08	+0.08	V	Full operating range	
Bias current monitor	DMI_Ibias	-10%	10%	mA		
	Dynamic	Range Accura	асу			
Transceiv er Temperature	DMI_Temp	-5	70	degC		
TX Output optical power	DMI_TX	-1	+2	dBm		
RX Input optical power	DMI_RX	-18	0	dBm		
Transceiv er Supply voltage	DMI_VCC	3.0	3.6	V		
Bias current monitor	DMI_Ibias	0	100	mA		





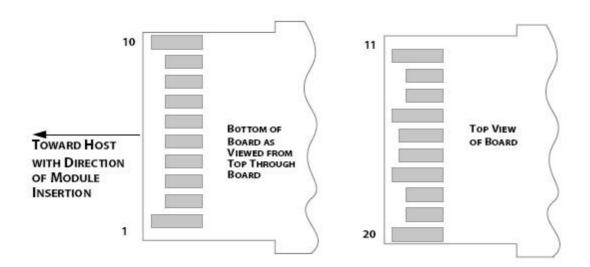


Figure 2. Electrical Pin-out Details



### **Pin Descriptions**

Pin	Symbol	Name/Description
1	VEET [1]	Transmitter Ground
2	Tx_FAULT[2]	Transmitter Fault
3	Tx_DIS [3]	Transmitter Disable. Laser output disabled on high or open
4	SDA [2]	2-wire Serial Interface Data Line
5	SCL [2]	2-wire Serial Interface Clock Line
6	MOD_ABS [4]	Module Absent. Grounded within the module
7	RS0 [5]	Rate Select 0
8	RX_LOS [2]	Loss of Signal indication. Logic 0 indicates normal operation
9	RS1 [5]	Rate Select 1
10	VEER [1]	Receiv er Ground
11	VEER [1]	Receiv er Ground
12	RD-	Receiver Inverted DATA out. AC Coupled
13	RD+	Receiver DATA out. AC Coupled
14	VEER [1]	Receiver Ground
15	VCCR	Receiv er Power Supply
16	VCCT	Transmitter PowerSupply
17	VEET [1]	Transmitter Ground
18	TD+	Transmitter DATA in. AC Coupled
19	TD-	Transmitter Inv erted DATA in. AC Coupled
20	VEET [1]	Transmitter Ground

- [1] Module circuit ground is isolated from module chassis ground within the module.
- [2]. should be pulled up with 4.7k 10k ohms on host board to a voltage between 3.15V and 3.6V.
- [3] Tx\_Disable is an input contact with a 4.7 k $\Omega$  to 10 k $\Omega$  pullup to VccT inside the module.
- [4] Mod\_ABS is connected to VeeT or VeeR in the SFP+ module. The host may pull this contact up to Vcc\_Host with a resistor in the range  $4.7 \text{ k}\Omega$  to  $10 \text{ k}\Omega$ . Mod\_ABS is asserted "High" when the SFP+ module is phy sically absent from a host slot. [5] RSO and RS1 are module inputs and are pulled low to VeeT with >  $30 \text{ k}\Omega$  resistors in the module.



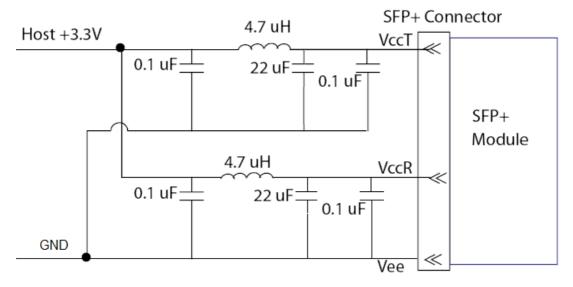


Figure 3. Host Board Power Supply Filters Circuit

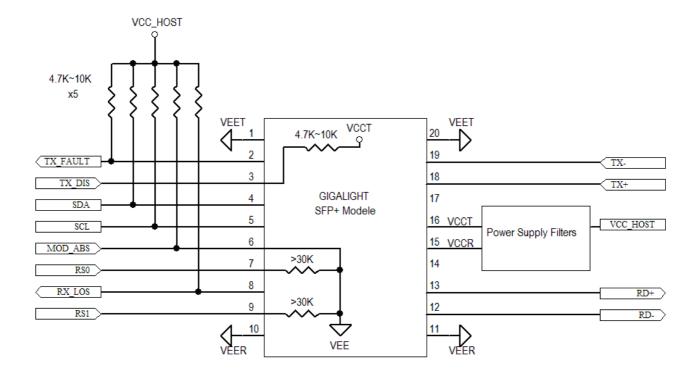


Figure 4. Host-Module Interface



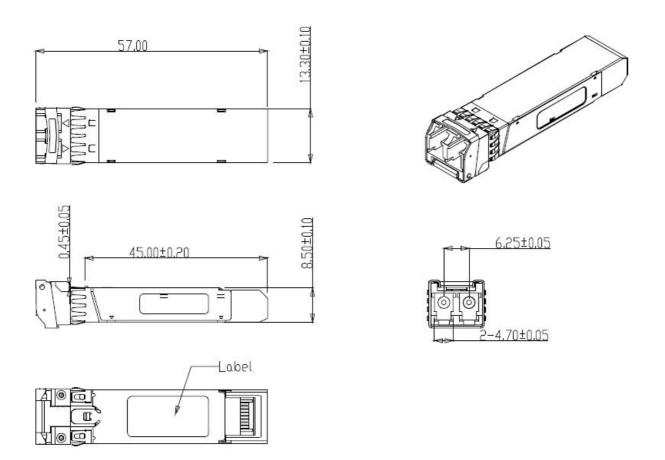


Figure 5. Mechanical Specifications

**Regulatory Compliance** 3C-LINKSFP+ transceiver is designed to be Class I Laser safety compliant and is certified per the following standards:

Feature	Agency	Standard	Certificate/ Comments
Laser Safety	FDA	CDRH 21 CFR 1040 annd Laser Notice No. 50	1120292-000
Product Safety	UL	UL and CUL EN60950-2:2007	E347511
Env ironmental protection	SGS	RoHS Directive 2002/95/EC	GZ1001008918/CHEM
EMC	WALTEK	EN 55022:2006+A1:2007 EN 55024:1998+A1+A2:2003	WT10093759-D-E-E



## Ordering information

Part Number	Product Description
3C-SFP+13-ER	10Gbps, 1310nm SFP+ 40km, -5°C~ +70°C

#### References

- 1. "Specifications for Enhanced Small Form Factor Pluggable Module SFP+", SFF-8431, Rev 4.1, July 6, 2009.
- 2. "Improved Pluggable Formfactor", SFF-8432, Rev 4.2, Apr 18, 2007
- 3. IEEE802.3ae 2002
- 4. "Diagnostic Monitoring Interface for Optical Transceivers" SFF-8472, Rev 10.3, Dec 1,2007











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